

FIG. 1

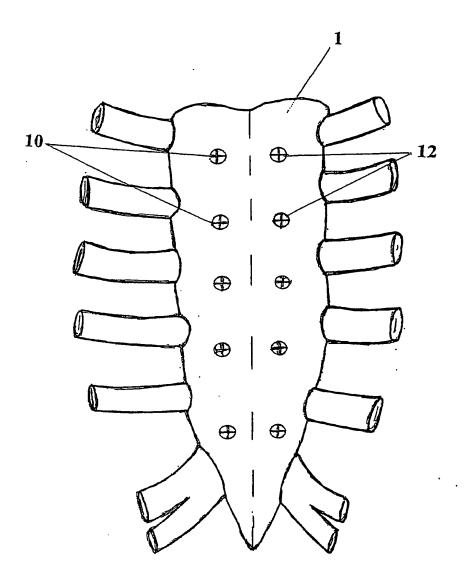


FIG. 2

٠.:

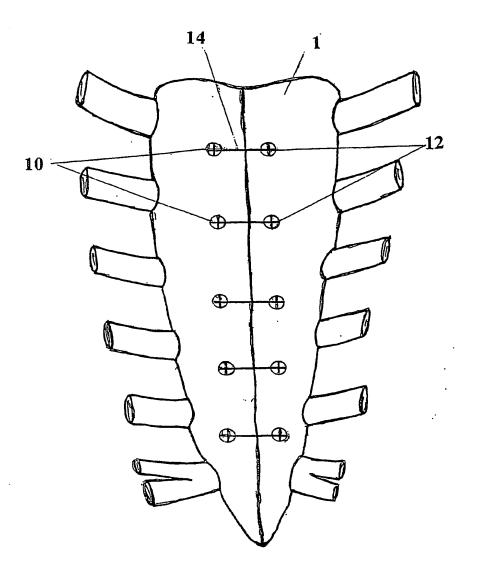


FIG. 3

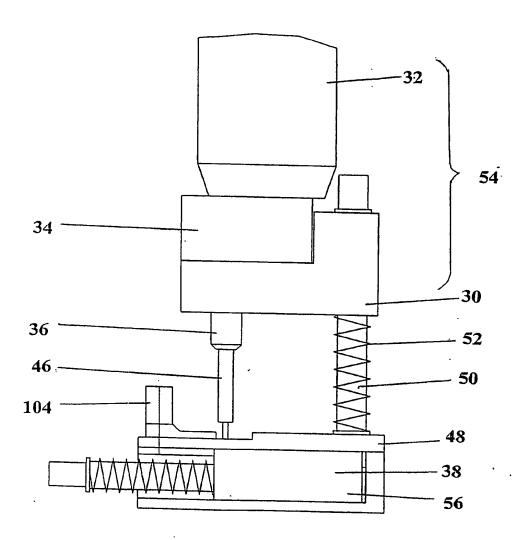


FIG. 4

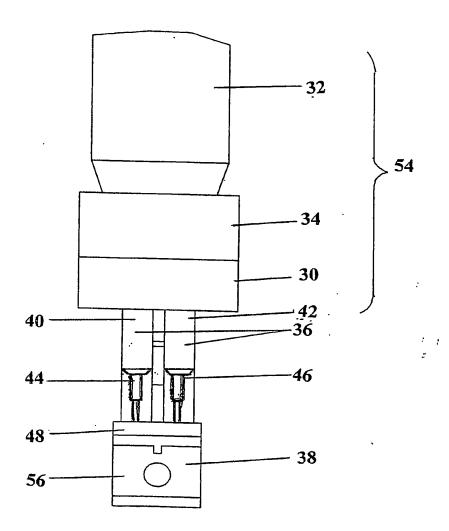
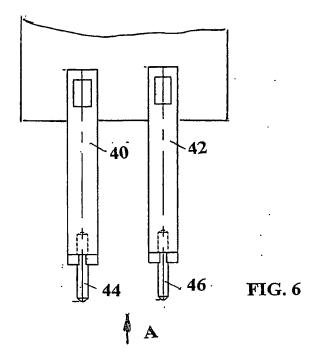


FIG. 5



View A

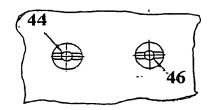
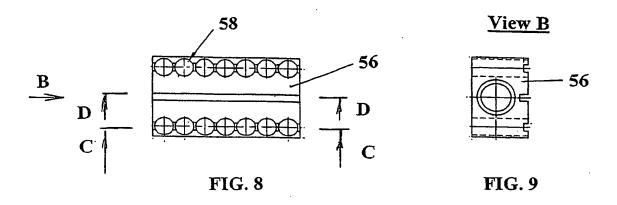
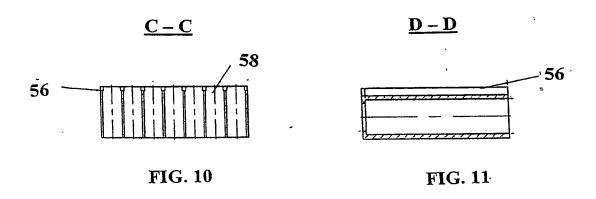


FIG. 7





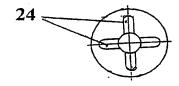


FIG. 12

WO 2004/078218 PCT/IL2004/000155 ,

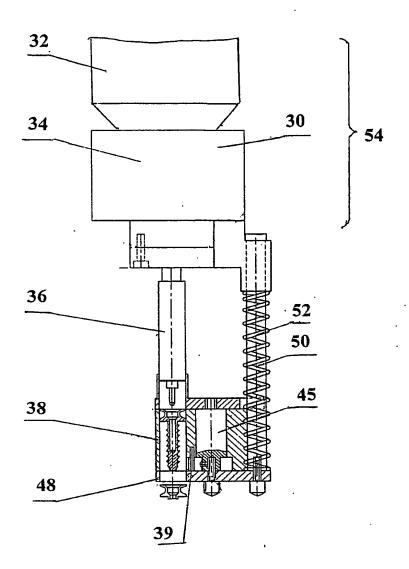


FIG. 13

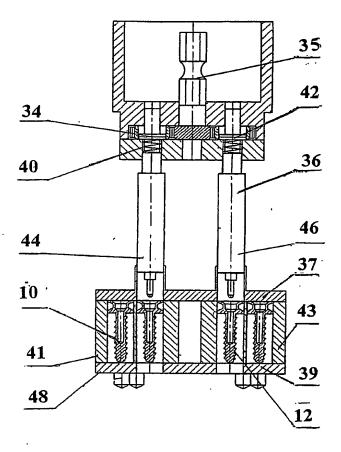


FIG. 14

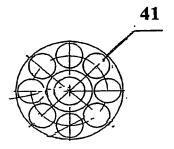


FIG. 15

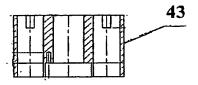


FIG. 16

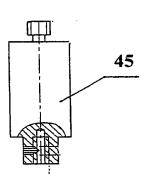


FIG. 17

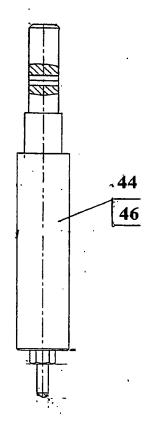


FIG. 18

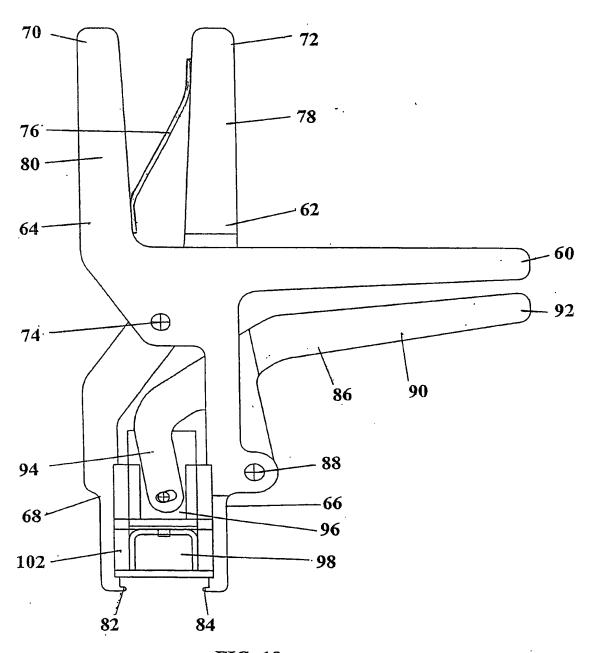


FIG. 19

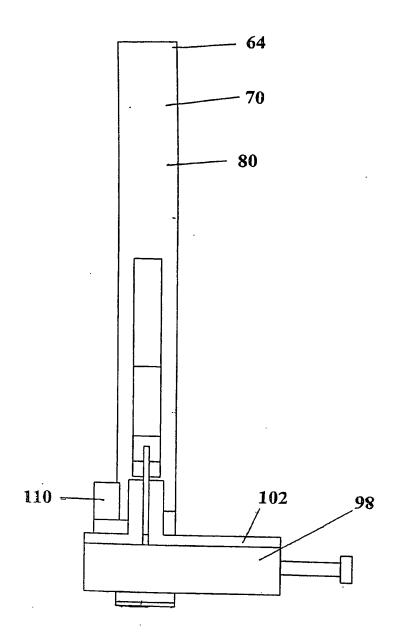


FIG. 20

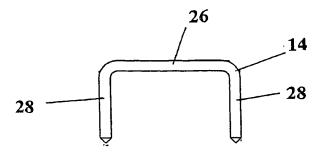


FIG. 21

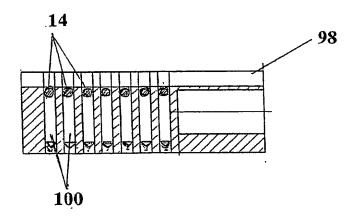
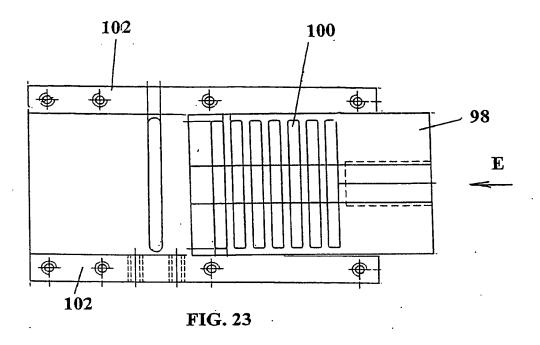


FIG. 22



View E

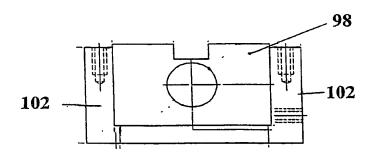


FIG. 24

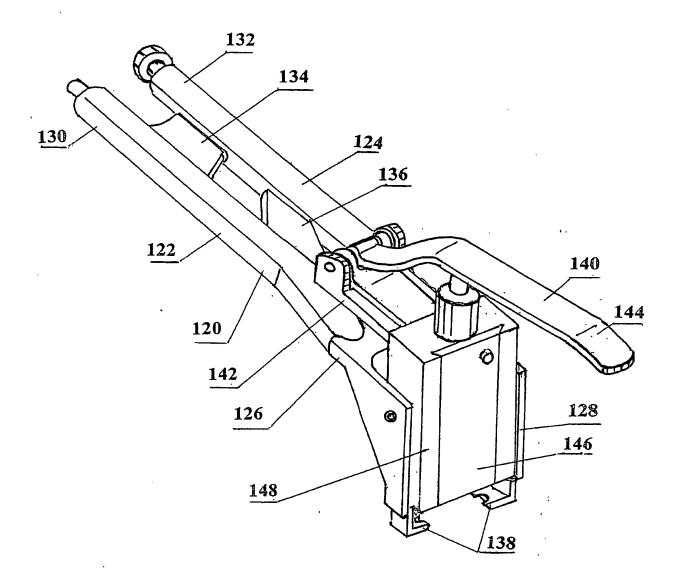


FIG. 25

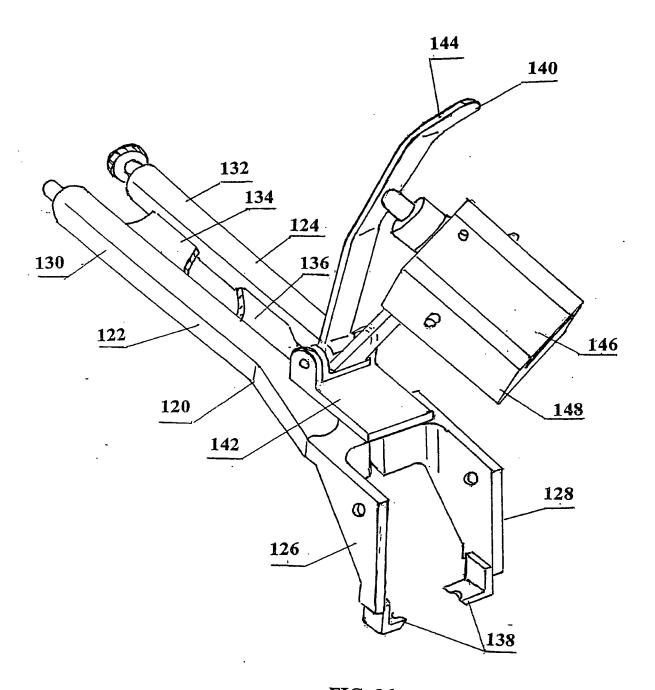


FIG. 26

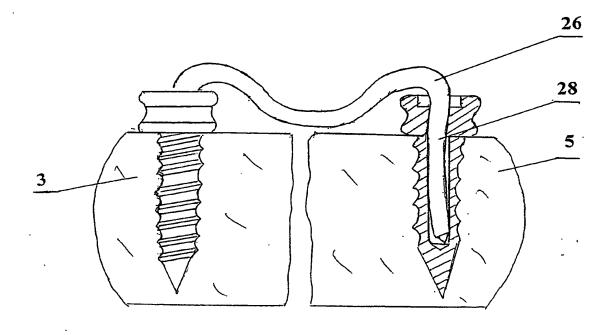
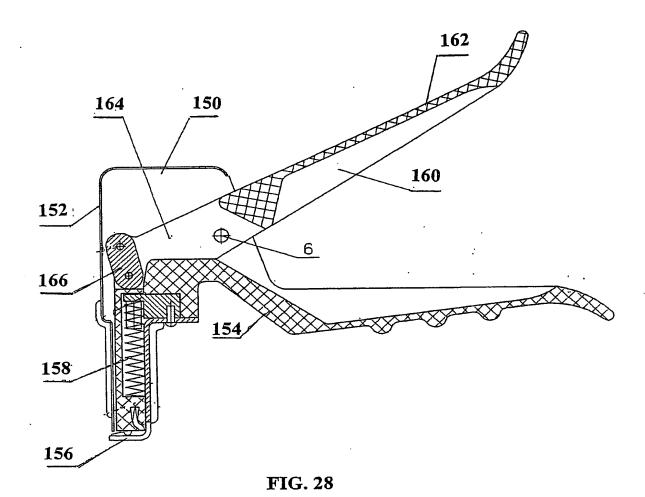


FIG. 27



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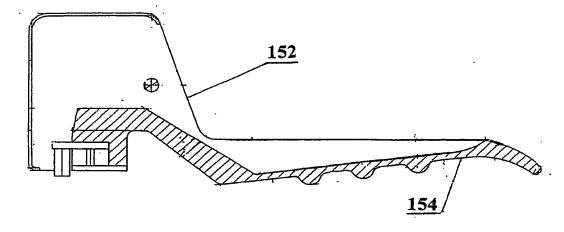


FIG. 29

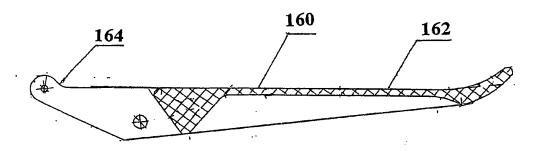


FIG. 30

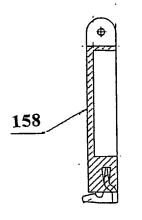


FIG. 31

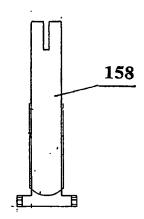


FIG. 32

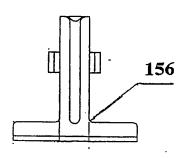


FIG. 33

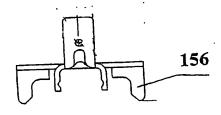


FIG. 34

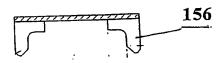


FIG. 35